

- Use **CDCVF2509A** as a Replacement for this Device
- Designed to Meet PC SDRAM Registered DIMM Design Support Document Rev. 1.2
- Spread Spectrum Clock Compatible
- Operating Frequency 25 MHz to 125 MHz
- Static tPhase Error Distribution at 66MHz to 100 MHz is  $\pm 150$  ps
- Drop-In Replacement for TI CDC2509A With Enhanced Performance
- Jitter (cyc – cyc) at 66 MHz to 100 MHz is  $\pm 100$  ps
- Available in Plastic 24-Pin TSSOP
- Phase-Lock Loop Clock Distribution for Synchronous DRAM Applications
- Distributes One Clock Input to One Bank of Five and One Bank of Four Outputs
- Separate Output Enable for Each Output Bank
- External Feedback (FBIN) Terminal Is Used to Synchronize the Outputs to the Clock Input
- On-Chip Series Damping Resistors
- No External RC Network Required
- Operates at 3.3 V

**PW PACKAGE  
(TOP VIEW)**



### description

The CDC2509C is a high-performance, low-skew, low-jitter, phase-lock loop (PLL) clock driver. It uses a PLL to precisely align, in both frequency and phase, the feedback (FBOUT) output to the clock (CLK) input signal. It is specifically designed for use with synchronous DRAMs. The CDC2509C operates at 3.3 V  $V_{CC}$ . It also provides integrated series-damping resistors that make it ideal for driving point-to-point loads.

One bank of five outputs and one bank of four outputs provide nine low-skew, low-jitter copies of CLK. Output signal duty cycles are adjusted to 50%, independent of the duty cycle at CLK. Each bank of outputs is enabled or disabled separately via the control (1G and 2G) inputs. When the G inputs are high, the outputs switch in phase and frequency with CLK; when the G inputs are low, the outputs are disabled to the logic-low state.

Unlike many products containing PLLs, the CDC2509C does not require external RC networks. The loop filter for the PLL is included on-chip, minimizing component count, board space, and cost.

Because it is based on PLL circuitry, the CDC2509C requires a stabilization time to achieve phase lock of the feedback signal to the reference signal. This stabilization time is required, following power up and application of a fixed-frequency, fixed-phase signal at CLK, and following any changes to the PLL reference or feedback signals. The PLL can be bypassed for test purposes by strapping  $AV_{CC}$  to ground.

The CDC2509C is characterized for operation from 0°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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CDC2509C  
3.3-V PHASE-LOCK LOOP CLOCK DRIVER

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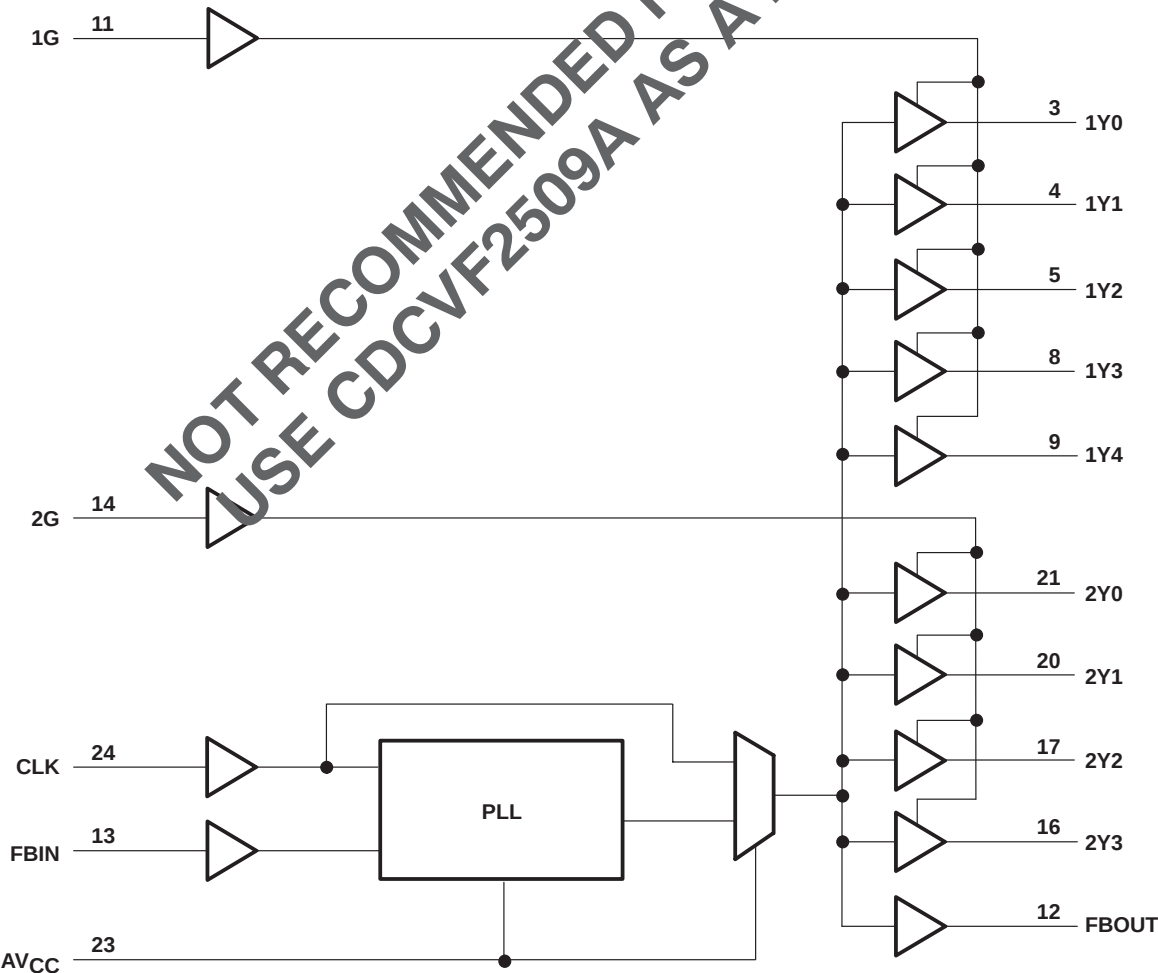
description (continued)

For application information refer to application reports *High Speed Distribution Design Techniques for CDC509/516/2509/2510/2516* (literature number SLMA003) and *Using CDC2509A/2510A PLL with Spread Spectrum Clocking (SSC)* (literature number SCAA039).

FUNCTION TABLE

| INPUTS |    |     | OUTPUTS     |             |       |
|--------|----|-----|-------------|-------------|-------|
| 1G     | 2G | CLK | 1Y<br>(0:4) | 2Y<br>(0:3) | FBOUT |
| X      | X  | L   | L           | L           | L     |
| L      | L  | H   | L           | L           | H     |
| L      | H  | H   | L           | H           | H     |
| H      | L  | H   | H           | L           | H     |
| H      | H  | H   | H           | H           | H     |

functional block diagram



AVAILABLE OPTIONS



# CDC2509C

## 3.3-V PHASE-LOCK LOOP CLOCK DRIVER

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| T <sub>A</sub> | PACKAGE            |
|----------------|--------------------|
|                | SMALL OUTLINE (PW) |
| 0°C to 85°C    | CDC2509CPWR        |

### Terminal Functions

| TERMINAL         |                | TYPE   | DESCRIPTION                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
|------------------|----------------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME             | NO.            |        |                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| CLK              | 24             | I      | Clock input. CLK provides the clock signal to be distributed by the CDC2509C clock driver. CLK is used to provide the reference signal to the integrated PLL that generates the clock output signals. CLK must have a fixed frequency and fixed phase for the PLL to obtain phase lock. Once the circuit is powered up and a valid CLK signal is applied, a stabilization time is required for the PLL to phase lock the feedback signal to its reference signal. |
| FBIN             | 13             | I      | Feedback input. FBIN provides the feedback signal to the internal PLL. FBIN must be hard-wired to FBOUT to complete the PLL. The integrated PLL synchronizes CLK and FBIN so that there is nominally zero phase error between CLK and FBIN.                                                                                                                                                                                                                       |
| 1G               | 11             | I      | Output bank enable. 1G is the output enable for outputs 1Y(0:4). When 1G is low, outputs 1Y(0:4) are disabled to a logic-low state. When 1G is high, all outputs 1Y(0:4) are enabled and switch at the same frequency as CLK.                                                                                                                                                                                                                                     |
| 2G               | 14             | I      | Output bank enable. 2G is the output enable for outputs 2Y(0:3). When 2G is low, outputs 2Y(0:3) are disabled to a logic-low state. When 2G is high, all outputs 2Y(0:3) are enabled and switch at the same frequency as CLK.                                                                                                                                                                                                                                     |
| FBOUT            | 12             | O      | Feedback output. FBOUT is dedicated for external feedback. It switches at the same frequency as CLK. When externally wired to FBIN, FBOUT completes the feedback loop of the PLL. FBOUT has an integrated 25-Ω series-damping resistor.                                                                                                                                                                                                                           |
| 1Y (0:4)         | 3, 4, 5, 8, 9  | O      | Clock outputs. These outputs provide low-skew copies of CLK. Output bank 1Y(0:4) is enabled via the 1G input. These outputs can be disabled to a logic-low state by deasserting the 1G control input. Each output has an integrated 25-Ω series-damping resistor.                                                                                                                                                                                                 |
| 2Y (0:3)         | 21, 20, 17, 16 | O      | Clock outputs. These outputs provide low-skew copies of CLK. Output bank 2Y(0:3) is enabled via the 2G input. These outputs can be disabled to a logic-low state by deasserting the 2G control input. Each output has an integrated 25-Ω series-damping resistor.                                                                                                                                                                                                 |
| AV <sub>CC</sub> | 23             | Power  | Analog power supply. AV <sub>CC</sub> provides the power reference for the analog circuitry. In addition, AV <sub>CC</sub> can be used to bypass the PLL for test purposes. When AV <sub>CC</sub> is strapped to ground, PLL is bypassed and CLK is buffered directly to the device outputs.                                                                                                                                                                      |
| AGND             | 1              | Ground | Analog ground. AGND provides the ground reference for the analog circuitry.                                                                                                                                                                                                                                                                                                                                                                                       |
| V <sub>CC</sub>  | 2, 10, 15, 22  | Power  | Power supply                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| GND              | 6, 7, 18, 19   | Ground | Ground                                                                                                                                                                                                                                                                                                                                                                                                                                                            |

# CDC2509C

## 3.3-V PHASE-LOCK LOOP CLOCK DRIVER

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                                            |                                   |
|--------------------------------------------------------------------------------------------|-----------------------------------|
| Supply voltage range, $AV_{CC}$ (see Note 1)                                               | $AV_{CC} < V_{CC} + 0.7\text{ V}$ |
| Supply voltage range, $V_{CC}$                                                             | -0.5 V to 4.6 V                   |
| Input voltage range, $V_I$ (see Note 2)                                                    | -0.5 V to 6.5 V                   |
| Voltage range applied to any output in the high or low state,<br>$V_O$ (see Notes 2 and 3) | -0.5 V to $V_{CC} + 0.5\text{ V}$ |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                                                | -50 mA                            |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ )                             | ±50 mA                            |
| Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )                                 | ±50 mA                            |
| Continuous current through each $V_{CC}$ or GND                                            | ±100 mA                           |
| Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 4)          | 0.7 W                             |
| Storage temperature range, $T_{stg}$                                                       | -65°C to 150°C                    |

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1.  $AV_{CC}$  **must not** exceed  $V_{CC}$ .

2. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

3. This value is limited to 4.6 V maximum.

4. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002.

### recommended operating conditions (see Note 5)

|                                      | MIN | MAX      | UNIT |
|--------------------------------------|-----|----------|------|
| $V_{CC}, AV_{CC}$ Supply voltage     | 3   | 3.6      | V    |
| $V_{IH}$ High-level input voltage    | 2   |          | V    |
| $V_{IL}$ Low-level input voltage     |     | 0.8      | V    |
| $V_I$ Input voltage                  | 0   | $V_{CC}$ | V    |
| $I_{OH}$ High-level output current   |     | -12      | mA   |
| $I_{OL}$ Low-level output current    |     | 12       | mA   |
| $T_A$ Operating free-air temperature | 0   | 85       | °C   |

NOTE 5: Unused inputs must be held high or low to prevent them from floating.

### timing requirements over recommended ranges of supply voltage and operating free-air temperature

|                                 | MIN | MAX | UNIT |
|---------------------------------|-----|-----|------|
| $f_{clk}$ Clock frequency       | 25  | 125 | MHz  |
| Input clock duty cycle          | 40% | 60% |      |
| Stabilization time <sup>†</sup> |     | 1   | ms   |

<sup>†</sup> Time required for the integrated PLL circuit to obtain phase lock of its feedback signal to its reference signal. For phase lock to be obtained, a fixed-frequency, fixed-phase reference signal must be present at CLK. Until phase lock is obtained, the specifications for propagation delay, skew, and jitter parameters given in the switching characteristics table are not applicable. This parameter does not apply for input modulation under SSC application.

# CDC2509C

## 3.3-V PHASE-LOCK LOOP CLOCK DRIVER

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                    |                           | TEST CONDITIONS                                                                   | V <sub>CC</sub> , AV <sub>CC</sub> | MIN                  | TYP <sup>‡</sup> | MAX  | UNIT |
|------------------------------|---------------------------|-----------------------------------------------------------------------------------|------------------------------------|----------------------|------------------|------|------|
| V <sub>IK</sub>              | Input clamp voltage       | I <sub>I</sub> = -18 mA                                                           | 3 V                                |                      |                  | -1.2 | V    |
| V <sub>OH</sub>              | High-level output voltage | I <sub>OH</sub> = -100 μA                                                         | MIN to MAX                         | V <sub>CC</sub> -0.2 |                  |      | V    |
|                              |                           | I <sub>OH</sub> = -12 mA                                                          | 3 V                                | 2.1                  |                  |      |      |
|                              |                           | I <sub>OH</sub> = -6 mA                                                           | 3 V                                | 2.4                  |                  |      |      |
| V <sub>OL</sub>              | Low-level output voltage  | I <sub>OL</sub> = 100 μA                                                          | MIN to MAX                         |                      |                  | 0.2  | V    |
|                              |                           | I <sub>OL</sub> = 12 mA                                                           | 3 V                                |                      |                  | 0.8  |      |
|                              |                           | I <sub>OL</sub> = 6 mA                                                            | 3 V                                |                      |                  | 0.55 |      |
| I <sub>OH</sub>              | High-level output current | V <sub>O</sub> = 1 V                                                              | 3.135 V                            |                      |                  | -32  | mA   |
|                              |                           | V <sub>O</sub> = 1.65 V                                                           | 3.3 V                              |                      |                  | -36  |      |
|                              |                           | V <sub>O</sub> = 3.135 V                                                          | 3.465 V                            |                      |                  | -12  |      |
| I <sub>OL</sub>              | Low-level output current  | V <sub>O</sub> = 1.95 V                                                           | 2.135 V                            |                      | 34               |      | mA   |
|                              |                           | V <sub>O</sub> = 1.65 V                                                           | 3.3 V                              |                      | 40               |      |      |
|                              |                           | V <sub>O</sub> = 0.4 V                                                            | 3.465 V                            |                      | 14               |      |      |
| I <sub>I</sub>               | Input current             | V <sub>I</sub> = V <sub>CC</sub> or GND                                           | 3.6 V                              |                      |                  | ±5   | μA   |
| I <sub>CC</sub> <sup>§</sup> | Supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>O</sub> = 0, Outputs: low or high | 3.6 V                              |                      |                  | 10   | μA   |
| ΔI <sub>CC</sub>             | Change in supply current  | One input at V <sub>CC</sub> - 0.6 V, Other inputs = V <sub>CC</sub> or GND       | 3.3 V to 3.6 V                     |                      |                  | 500  | μA   |
| C <sub>i</sub>               | Input capacitance         | V <sub>I</sub> = V <sub>CC</sub> or GND                                           | 3.3 V                              |                      |                  | 4    | pF   |
| C <sub>O</sub>               | Output capacitance        | V <sub>O</sub> = V <sub>CC</sub> or GND                                           | 3.3 V                              |                      |                  | 6    | pF   |

<sup>‡</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>§</sup> For I<sub>CC</sub> of AV<sub>CC</sub>, and I<sub>CC</sub> vs Frequency (see Figures 11 and 12).

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C<sub>L</sub> = 30 pF (see Note 6 and Figures 1 and 2)<sup>‡</sup>

| PARAMETER                                                     |                               | FROM<br>(INPUT)/CONDITION                           | TO<br>(OUTPUT) | V <sub>CC</sub> , AV <sub>CC</sub> = 3.3 V<br>± 0.165 V |     |     | UNIT |
|---------------------------------------------------------------|-------------------------------|-----------------------------------------------------|----------------|---------------------------------------------------------|-----|-----|------|
|                                                               |                               |                                                     |                | MIN                                                     | TYP | MAX |      |
| Phase error time – static (normalized)<br>(See Figures 3 – 5) |                               | CLKIN↑ = 66 MHz to 100 MHz                          | FBIN↑          | –150                                                    |     | 150 | ps   |
| t <sub>sk(o)</sub>                                            | Output skew time <sup>§</sup> | Any Y or FBOUT                                      | Any Y or FBOUT |                                                         |     | 200 | ps   |
| Phase error time – jitter (see Note 7)                        |                               | Clkin = 66 MHz to 100 MHz                           | Any Y or FBOUT | –50                                                     |     | 50  | ps   |
| Jitter <sub>(cycle-cycle)</sub><br>(See Figures 9 and 10)     |                               |                                                     | Any Y or FBOUT |                                                         |     | 100 |      |
| Duty cycle                                                    |                               | F(clkin > 60 MHz)                                   | Any Y or FBOUT | 45%                                                     |     | 55% |      |
| t <sub>r</sub>                                                | Rise time (See Notes 8 and 9) | V <sub>O</sub> = 1.2 V to 1.8 V,<br>IBIS simulation | Any Y or FBOUT | 2.5                                                     |     | 1   | V/ns |
| t <sub>f</sub>                                                | Fall time (See Notes 8 and 9) | V <sub>O</sub> = 1.2 V to 1.8 V,<br>IBIS simulation | Any Y or FBOUT | 2.5                                                     |     | 1   | V/ns |

<sup>‡</sup> These parameters are not production tested.

<sup>§</sup> The t<sub>sk(o)</sub> specification is only valid for equal loading of all outputs.

NOTES: 6. The specifications for parameters in this table are applicable only after any appropriate stabilization time has elapsed.

7. Calculated per PC DRAM SPEC (t<sub>phase error, static – jitter</sub><sub>(cycle-to-cycle)</sub>).

8. This is equivalent to 0.8 ns/2.5 ns and 0.8 ns/2.7 ns into standard 500 Ω/ 30 pF load for output swing of 0.4 V to 2 V.

9. 64 MB DIMM configuration according to PC SDRAM Registered DIMM Design Support Document, Figure 20 and Table 13.

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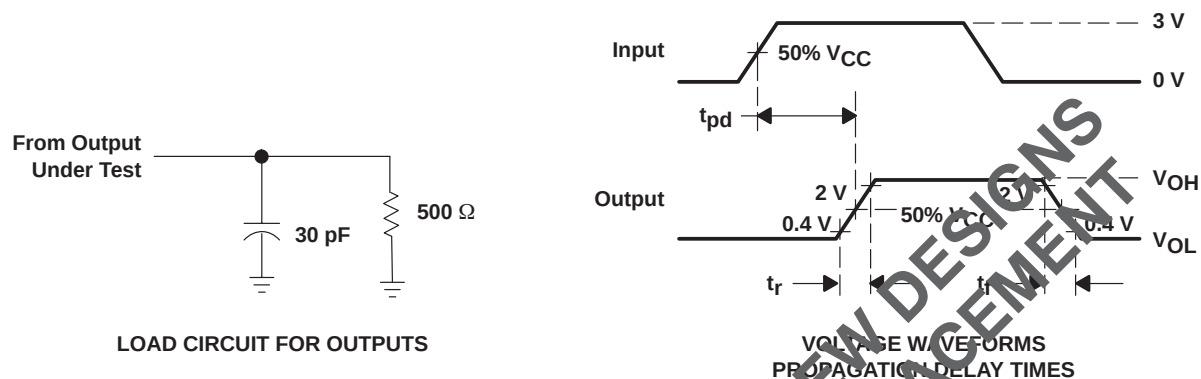
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# CDC2509C

## 3.3-V PHASE-LOCK LOOP CLOCK DRIVER

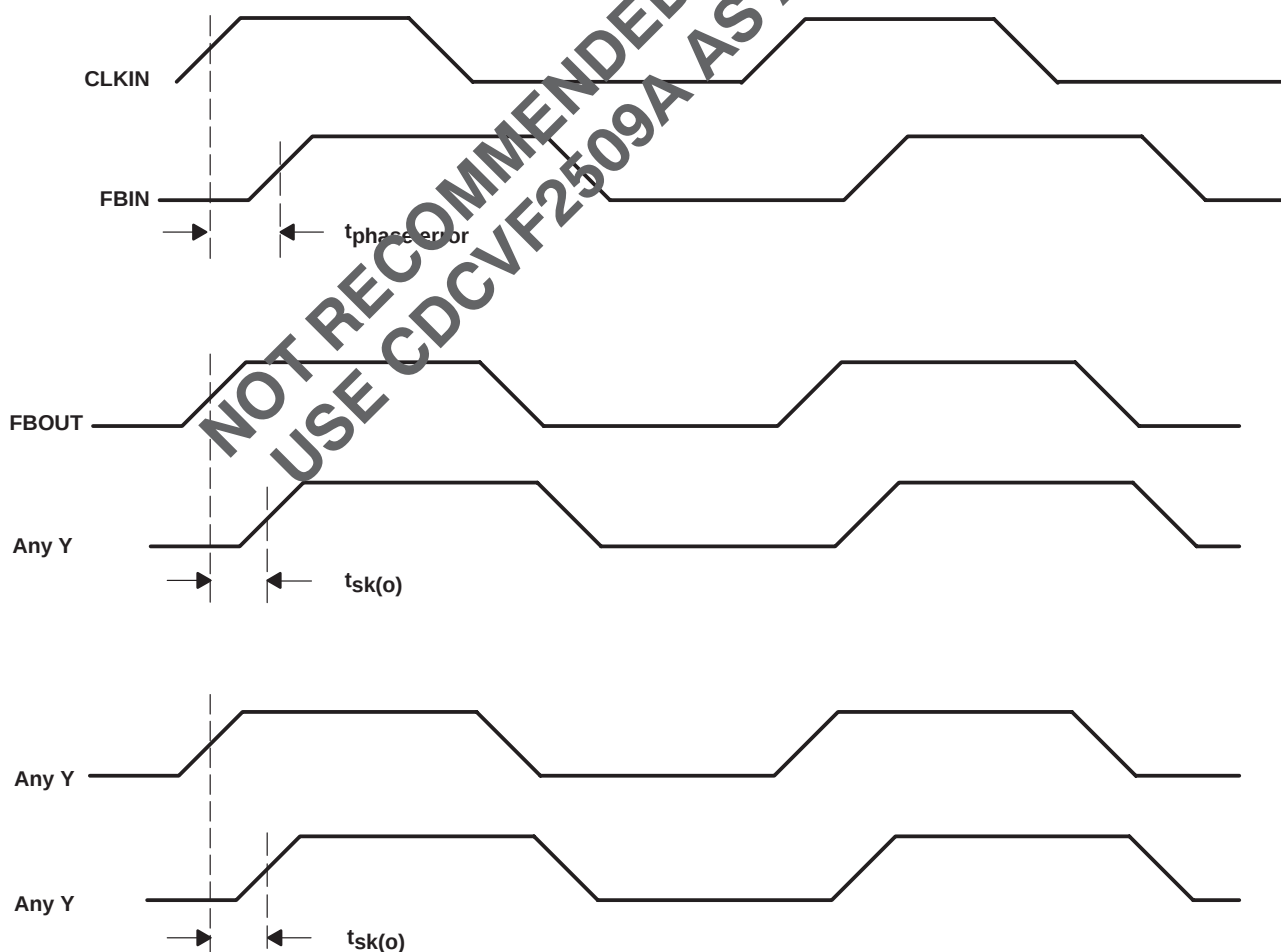
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### PARAMETER MEASUREMENT INFORMATION



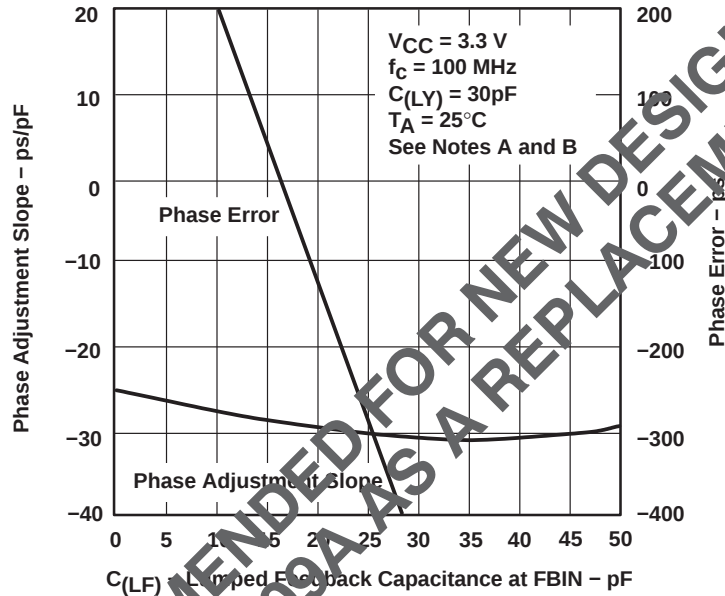
- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. All input pulses are supplied by generators having the following characteristics:  $PRN \leq 100$  MHz,  $Z_O = 50 \Omega$ ,  $t_r \leq 1.2$  ns,  $t_f \leq 1.2$  ns.  
C. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



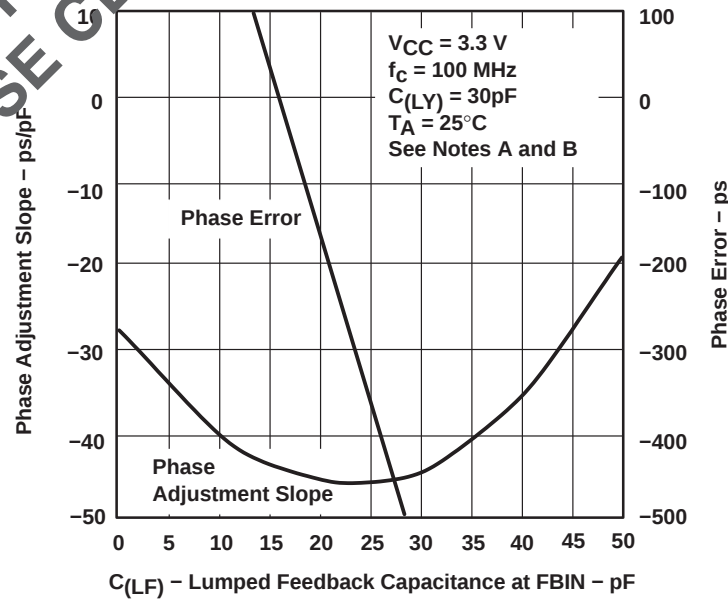
## TYPICAL CHARACTERISTICS

**CDC2509C**  
**PHASE ADJUSTMENT SLOPE AND PHASE ERROR**  
**VS**  
**LOAD CAPACITANCE**



**Figure 3**

**CDC2509A**  
**PHASE ADJUSTMENT SLOPE AND PHASE ERROR**  
**VS**  
**LOAD CAPACITANCE**



**Figure 4**

NOTES: A. Trace feedback length FBOUT to FBIN = 5 mm,  $Z_O = 50\ \Omega$  Phase error measured from CLK to Y  
 B. CLF = Lumped feedback capacitance at FBIN

# CDC2509C

## 3.3-V PHASE-LOCK LOOP CLOCK DRIVER

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### TYPICAL CHARACTERISTICS

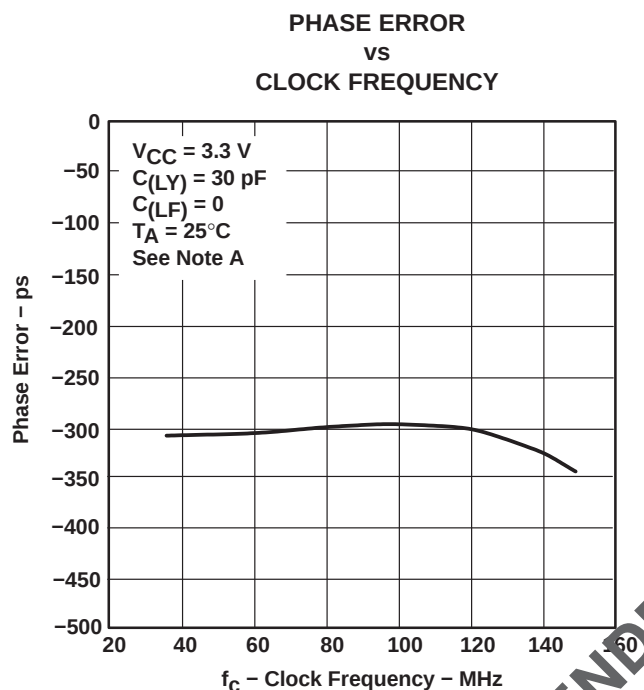


Figure 5

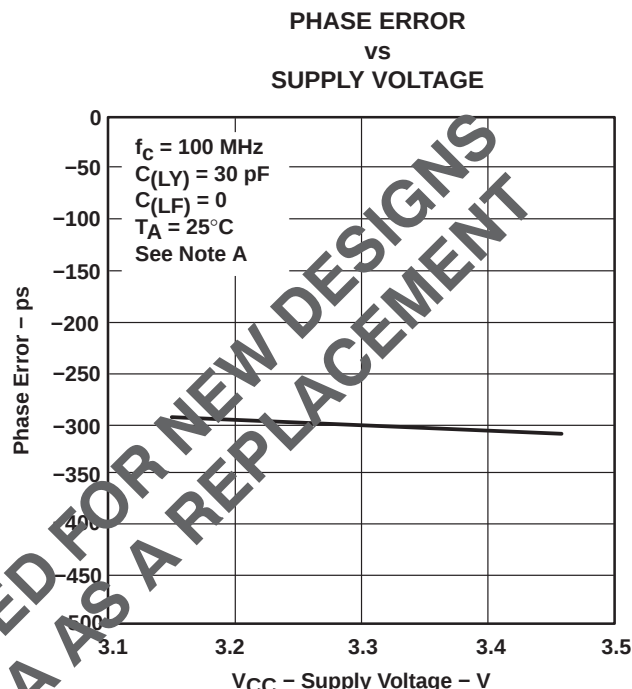


Figure 6

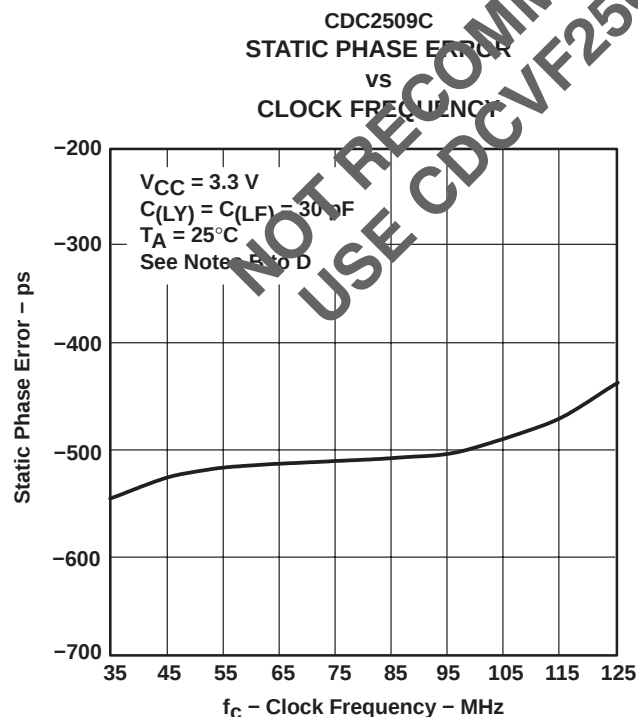


Figure 7

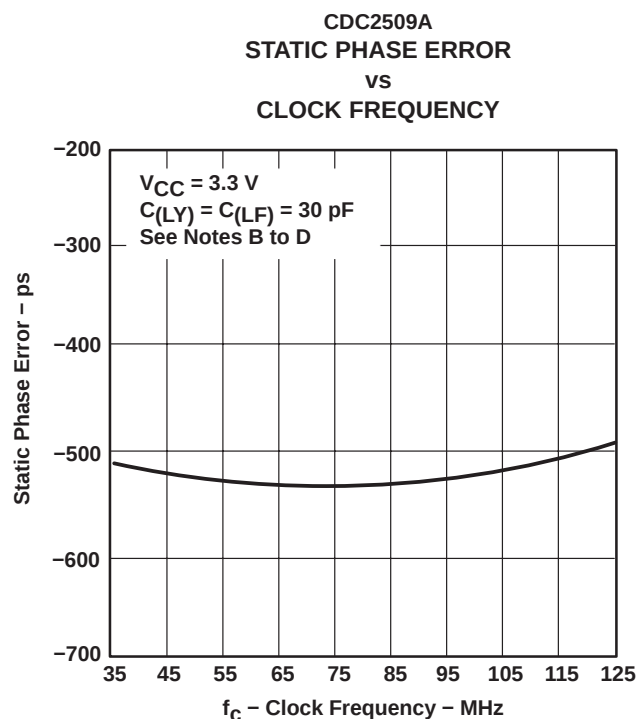
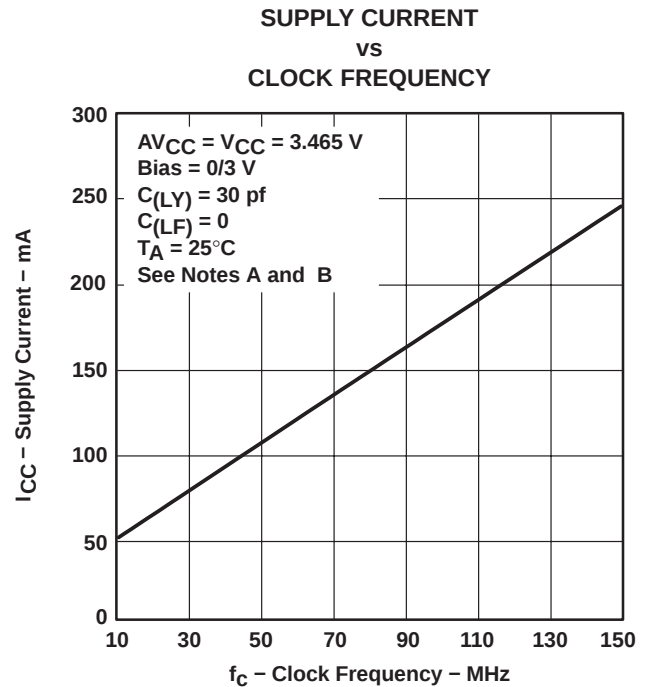
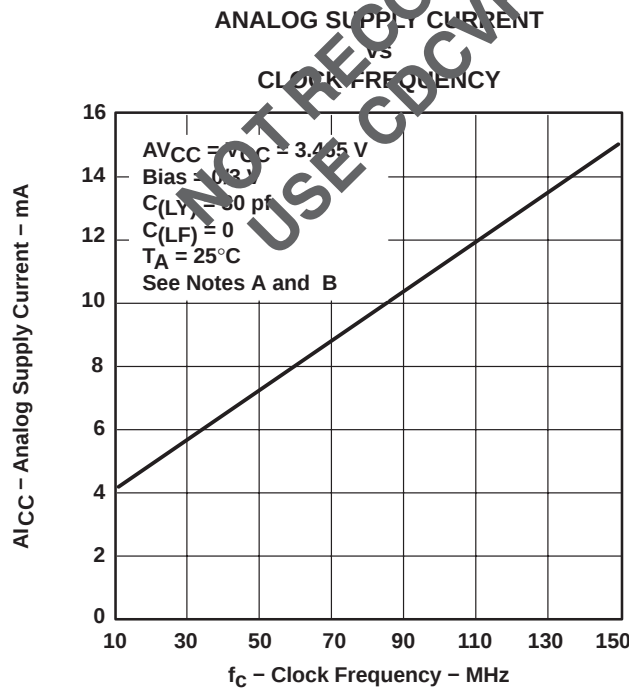
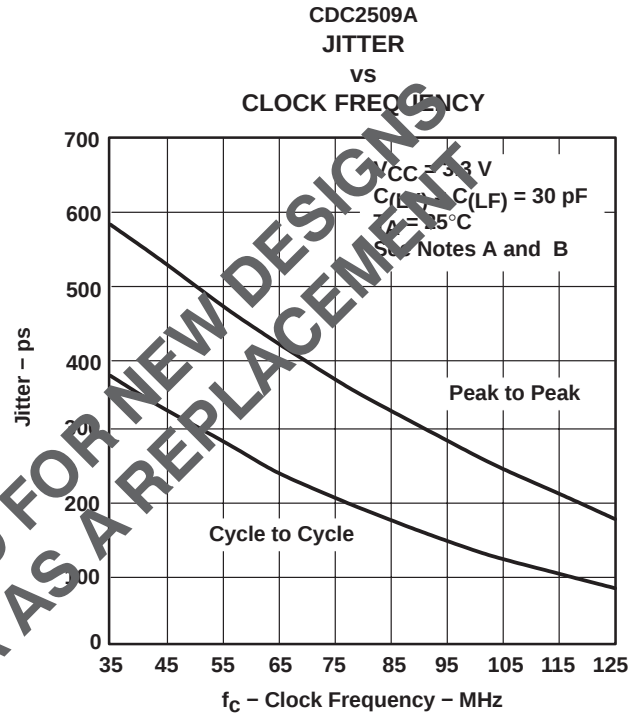
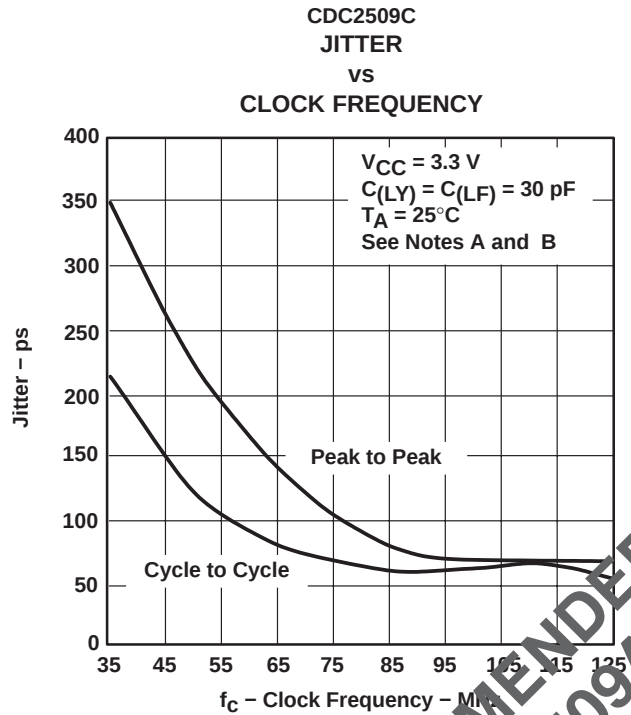


Figure 8

- NOTES: A. Trace feedback length FBOUT to FBIN = 5 mm,  $Z_0 = 50\ \Omega$   
 B. Phase error measured from CLK to FBIN  
 C. CLY = Lumped capacitive load at Y  
 D. CLF = Lumped feedback capacitance at FBIN

## TYPICAL CHARACTERISTICS



NOTES: A.  $C_{(LY)}$  = Lumped capacitive load at Y  
 B.  $C_{(LF)}$  = Lumped feedback capacitance at FBIN

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TYPICAL CHARACTERISTICS

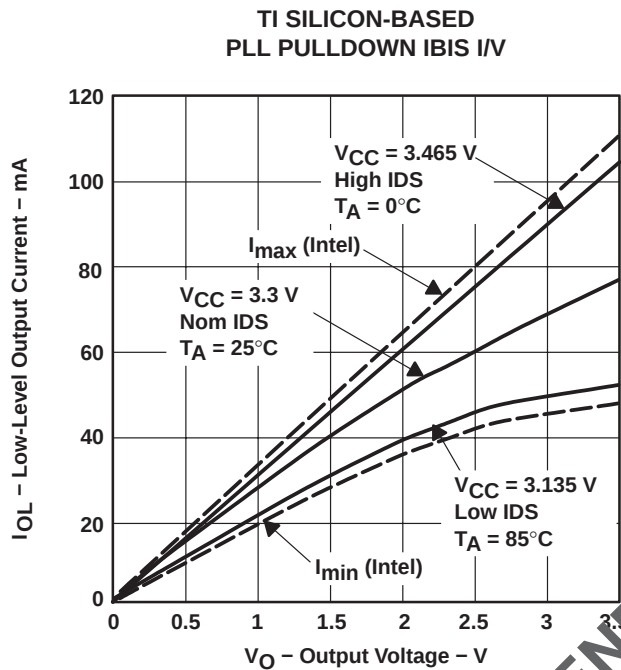


Figure 13

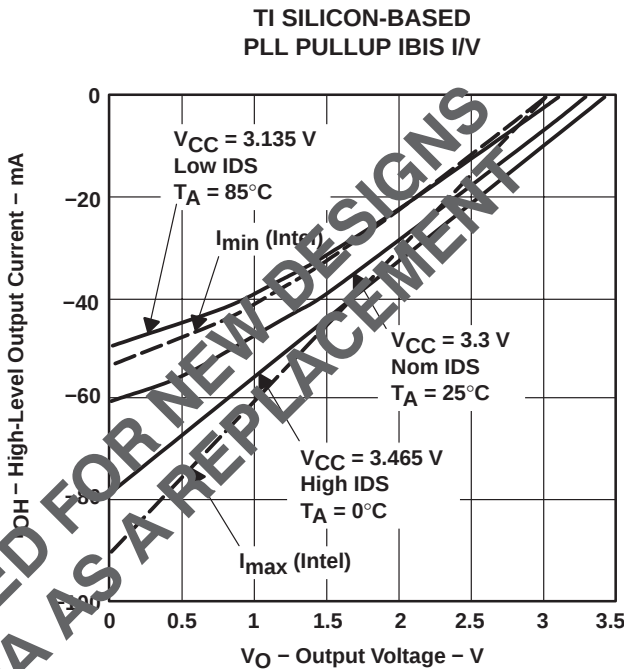


Figure 14

## PACKAGING INFORMATION

| Orderable part number | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C)    | Part marking<br>(6) |
|-----------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|-----------------|---------------------|
| CDC2509CPW            | NRND          | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -               | CK2509C             |
| CDC2509CPW.B          | NRND          | Production           | TSSOP (PW)   24 | 60   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | See CDC2509CPW  | CK2509C             |
| CDC2509CPWR           | NRND          | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -               | CK2509C             |
| CDC2509CPWR.B         | NRND          | Production           | TSSOP (PW)   24 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | See CDC2509CPWR | CK2509C             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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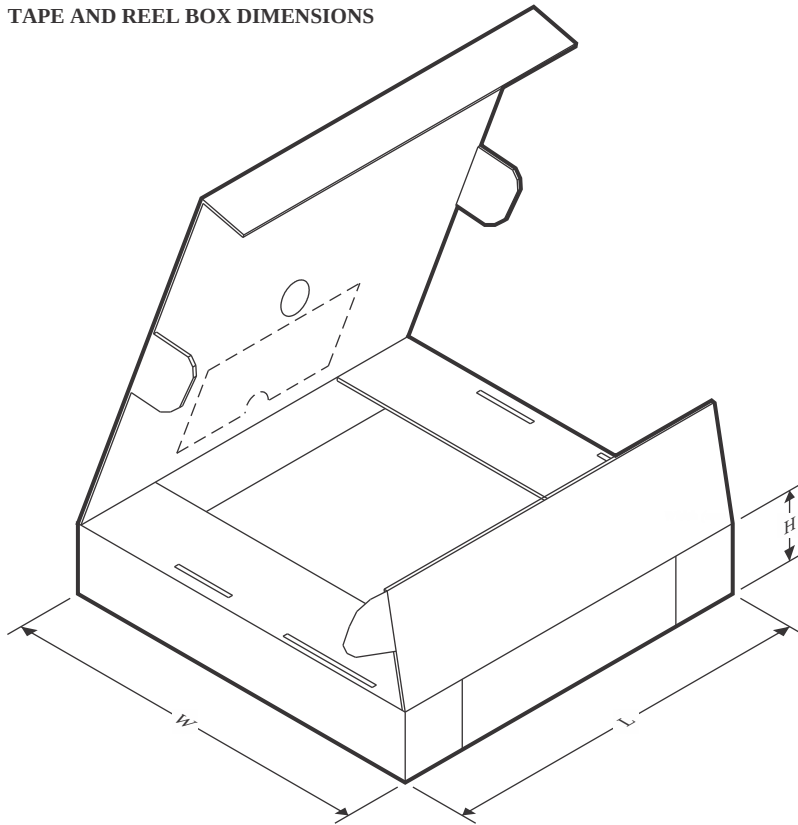
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CDC2509CPWR | TSSOP        | PW              | 24   | 2000 | 330.0              | 16.4               | 6.95    | 8.3     | 1.6     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CDC2509CPWR | TSSOP        | PW              | 24   | 2000 | 353.0       | 353.0      | 32.0        |

## TUBE



\*All dimensions are nominal

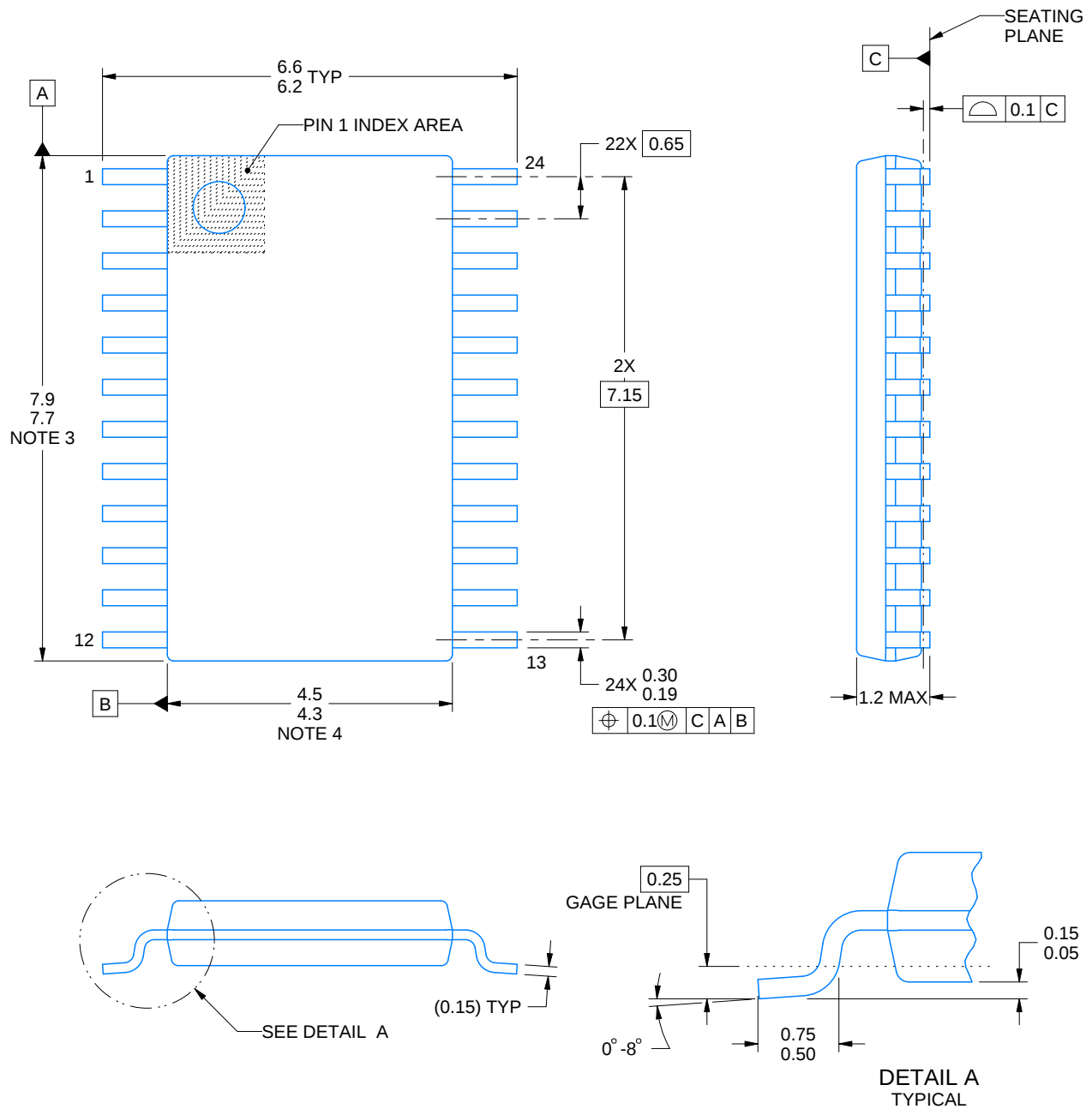
| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CDC2509CPW   | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |
| CDC2509CPW.B | PW           | TSSOP        | 24   | 60  | 530    | 10.2   | 3600   | 3.5    |

**PW0024A**

## PACKAGE OUTLINE

**TSSOP - 1.2 mm max height**

SMALL OUTLINE PACKAGE



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NOTES:

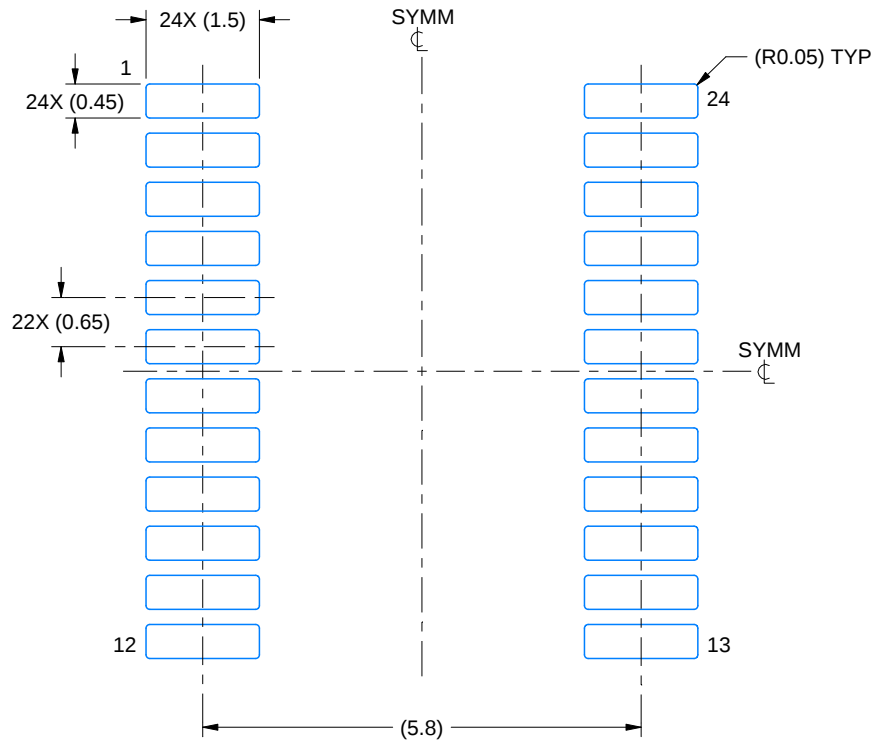
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

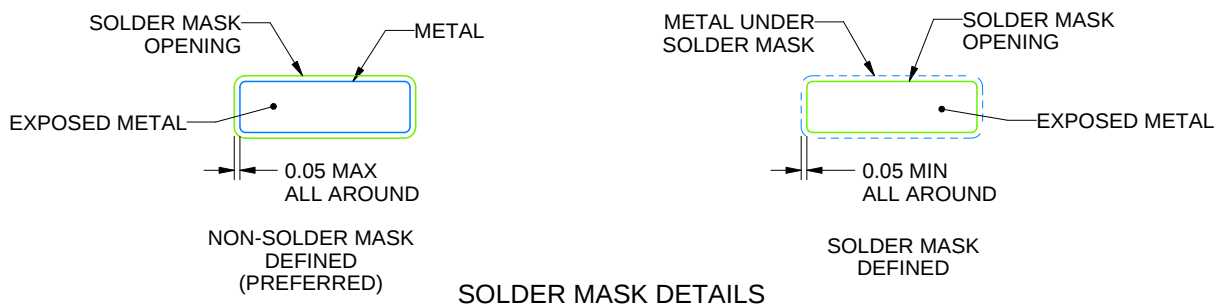
PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

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NOTES: (continued)

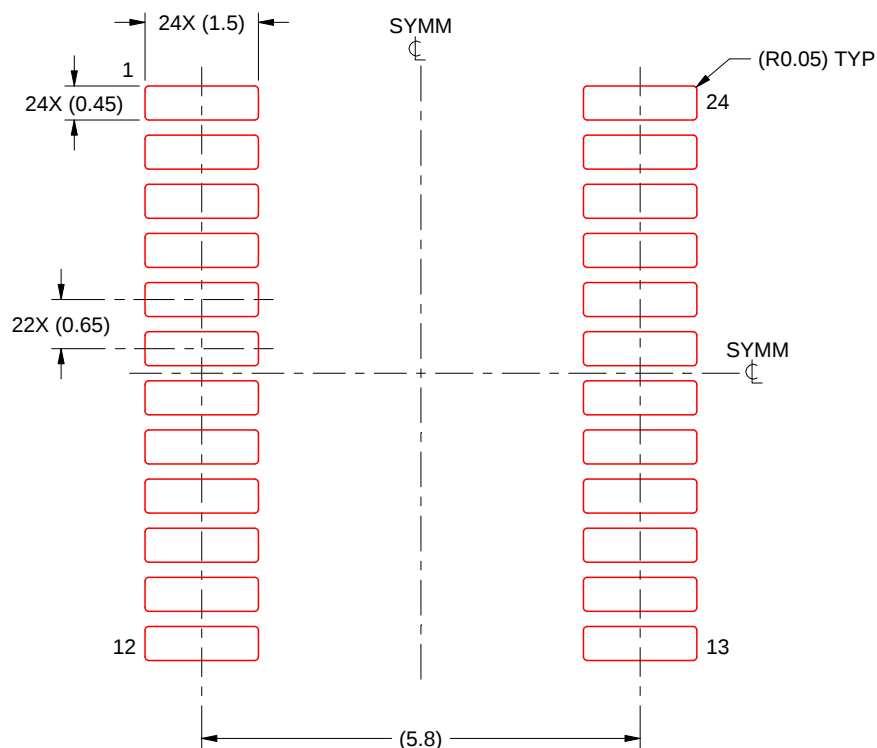
6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0024A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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